

FFH50US60S 50 A, 600 V, STEALTH™ Diode

Features

- Stealth Recovery, t_{rr} = 113 ns (@ I_F = 50 A)
- Max Forward Voltage, V_F = 1.54 V (@ T_C = 25°C)
- · 600V Reverse Voltage and High Reliability
- · Operating Temperature = 175°C
- · Avalanche Energy Rated
- · RoHS Compliant

Applications

- SMPS, Welders
- Power Factor Correction
- Uninterruptible Power Supplies
- Motor Drives

Description

The FFH50US60S is a STEALTHTM diode optimized for low loss performance in output rectification. The STEALTHTM family exhibits low reverse recovery current (I_{RR}), low V_F and soft recovery under typical operating conditions. This device is intended for use as an output rectification diode in Telecom power supplies and other power switching applications. Lower V_F and I_{RR} reduces diode losses. Formerly developmental type TA49468.

Package JEDEC STYLE 2 LEAD TO-247 ANODE CATHODE CATHODE

(BOTTOM SIDE — METAL)

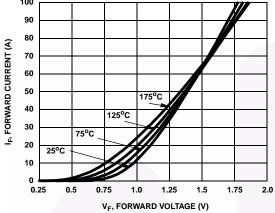
Device Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Rating	Unit	
V_{RRM}	Repetitive Peak Reverse Voltage	600	V	
V _{RWM}	Working Peak Reverse Voltage	600	V	
V _R	DC Blocking Voltage	600	V	
I _{F(AV)}	Average Rectified Forward Current (T _C = 120°C)	50	Α	
I _{FRM}	Repetitive Peak Surge Current (20kHz Square Wave)	100	Α	
I _{FSM}	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60 Hz)	500	Α	
P _D	Power Dissipation	200	W	
E _{AVL}	Avalanche Energy (1 A, 40 mH)	20	mJ	
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to 175	°C	
TL	Maximum Temperature for Soldering	300	°C	
T_{PKG}	Leads at 0.063 in (1.6mm) from Case for 10 s Package Body for 10s, See Application Note AN-7528			

CAUTION: Stresses above those listed in "Device Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Device Marking		Device	Package	Packing Meth	Packing Methode		Tape	Width	Qua	Quantity	
FFH50US60S		FFH50US60S	TO247-2L	Tube		N/A	N/A			30	
Electric	al Ch	aracteristic	S T _C = 25°C	unless otherwise	note	d			•		
Symbol	Parameter		Test Conditions		Min	Тур	Max	Unit			
Off State	Chara	cteristics									
I _R	Instantaneous Reverse Current		V _R = 600 V	Т	_C = 25°C	-	-	100	μA		
IX.					_C = 125°C	-	-	1	mA		
n State	Chara	cteristics		•		-	L		L		
		tantaneous Forward Voltage		I _F = 50 A	Т	_C = 25°C	_	1.38	1.54	V	
* F	motanta	inocao i ci mara v	onago	1F = 00 / 1		C = 125°C	_	1.37	1.53	V	
•		cteristics		IV 40 V I	0.4			140		T	
СЈ	Junction	n Capacitance		$V_R = 10 \text{ V}, I_F =$	0 A		-	110	-	pF	
witching	g Char	acteristics									
t _{rr}	Reverse Recovery Time			$I_F = 1 A, dI_F/dt =$	= 100 <i>F</i>	Vμs, V _R = 15 V	-	47	80	ns	
				$I_F = 50 \text{ A}, dI_F/dt$	= 100	$A/\mu s, V_R = 15$	/ -	75	124	ns	
t _{rr}	Reverse Recovery Time		$I_F = 50 \text{ A},$ $dI_F/dt = 200 \text{ A/}\mu\text{s},$ $V_R = 390 \text{ V}, T_C = 25^{\circ}\text{C}$			-	113	-	ns		
I_{RR}	Reverse Recovery Current					-	9.6	-	Α		
Q_{RR}	Reverse Recovered Charge				•	0.9	-	μC			
T_{rr}	Reverse Recovery Time Softness Factor (t _b /t _a) Reverse Recovery Current		$I_F = 50 \text{ A},$ $dI_F/dt = 200 \text{ A/}\mu\text{s},$ $V_R = 390 \text{V},$ $T_C = 125^{\circ}\text{C}$			-	235	-	ns		
S						-	1.5	-	-		
I_{RR}						-	15	-	Α		
Q_{RR}	Reverse	e Recovered Chai	ge			-	2.3	-	μC		
t _{rr}	Reverse	e Recovery Time		$I_F = 50 A,$			•	110	•	ns	
S	Softnes	s Factor (t _b /t _a)	$dI_F/dt = 1000 \text{ A/}\mu\text{s},$ $V_R = 390 \text{ V},$ $T_C = 125^{\circ}\text{C}$				0.8	•	-		
I_{RR}	Reverse	verse Recovery Current				•	46	•	Α		
Q_{RR}	Reverse	e Recovered Char	ge	16 - 120 0			-	3.1	-	μC	
dI _M /dt	Maximu	ım di/dt during t _b					-	1000	-	A/µs	
Thermal	Charac	cteristics									
$R_{\theta JC}$	Thermal Resistance Junction to Case						-	-	0.75	°C/W	
$R_{\theta JA}$	Thermal Resistance Junction to Ambient			t TO-247			-	-	30	°C/W	

Typical Performance Curves



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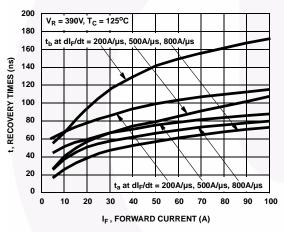
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Figure 1. Forward Current vs Forward Voltage

Figure 2. Reverse Current vs Reverse Voltage



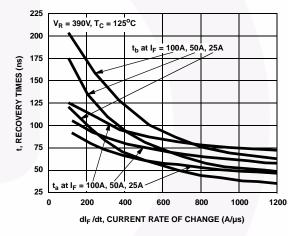
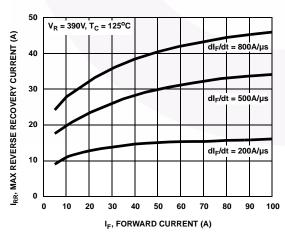


Figure 3. t_a and t_b Curves vs Forward Current

Figure 4. t_a and t_b Curves vs dl_F/dt



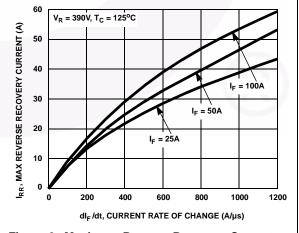


Figure 5. Maximum Reverse Recovery Current vs Forward Current

Figure 6. Maximum Reverse Recovery Current vs dI_F/dt

V_R = 390V, T_C = 125°C SOFTNESS FACTOR 2.2 2.0 1.8 _F = 100A 1.6 I_F = 50A REVERSE RECOVERY 1.4 I_F = 25A 1.2 1.0 0.8 ú 0.6 600 1200

Typical Performance Curves (Continued)

Figure 7. Reverse Recovery Softness Factor vs dI_F/dt

dI_F/dt, CURRENT RATE OF CHANGE (A/μs)

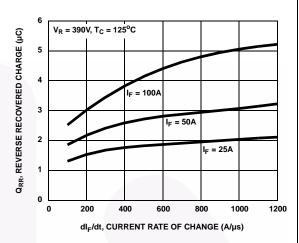


Figure 8. Reverse Recovery Charge vs dl_F/dt

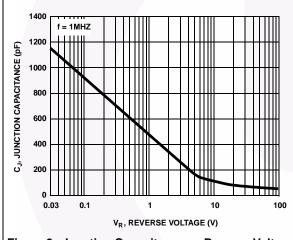


Figure 9. Junction Capacitance vs Reverse Voltage

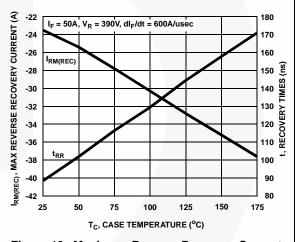


Figure 10. Maximum Reverse Recovery Current and t_{rr} vs Case Temperature

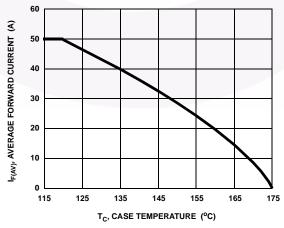


Figure 11. DC CURRENT DERATING CURVE

Typical Performance Curves (Continued)

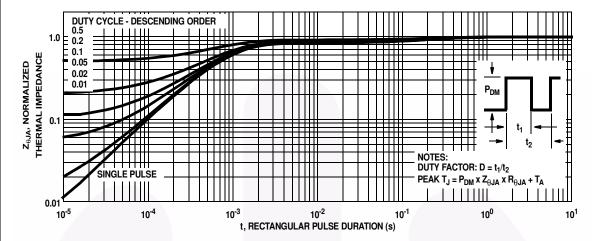
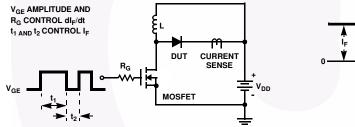


Figure 12. Normalized Maximum Transient Thermal Impedance

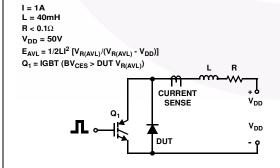
Test Circuit and Waveforms



 $0 \xrightarrow{I_F} \frac{dI_F}{dt}$ $1 \xrightarrow{I_F} t_a \xrightarrow{t_{fr}} t_b \xrightarrow{I_{fr}} 0.25 I_{fr}$ $1 \xrightarrow{I_{fr}} t_a \xrightarrow{I_{fr}} t_b \xrightarrow{I_{fr}} 0.25 I_{fr}$

Figure 13. t_{rr} Test Circuit

Figure 14. t_{rr} Waveforms and Definitions



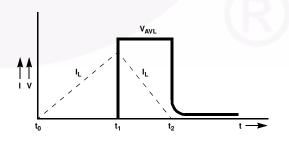


Figure 15. Avalanche Energy Test Circuit

Figure 16. Avalanche Current and Voltage Waveforms

Mechanical Dimensions

TO247-2L

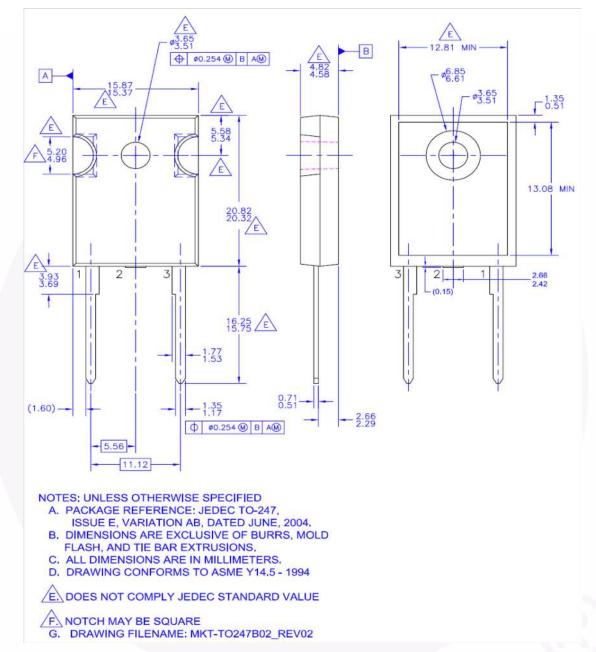


Figure 17. TO-247, Molded, 2LD, Jedec Option AB

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